SDLS205 - DECEMBER 1983 - REVISED MARCH 1988

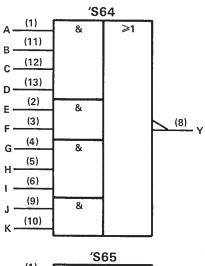
- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

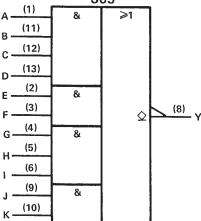
### description

These devices contain 4-2-3-2 input AND-OR-INVERT gates. They perform the Boolean function  $Y = \overline{ABCD + EF + GHI + JK}$ . The 'S64 has totem-pole outputs and the 'S65 has open-collector outputs.

The SN54S64 and the SN54S65 are characterized for operation over the full military temperature range of  $-55\,^{\circ}\text{C}$  to 125  $^{\circ}\text{C}$ . The SN74S64 and the SN74S65 are characterized for operation from 0  $^{\circ}\text{C}$  to 70  $^{\circ}\text{C}$ .

### logic symbols†

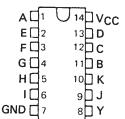




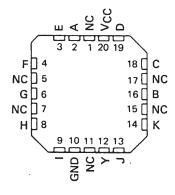
<sup>&</sup>lt;sup>†</sup>These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54S64, SN54S65 . . . J OR W PACKAGE SN74S64, SN74S65 . . . D OR N PACKAGE (TOP VIEW)

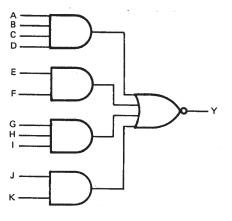


SN54S64, SN54S65 . . . FK PACKAGE (TOP VIEW)



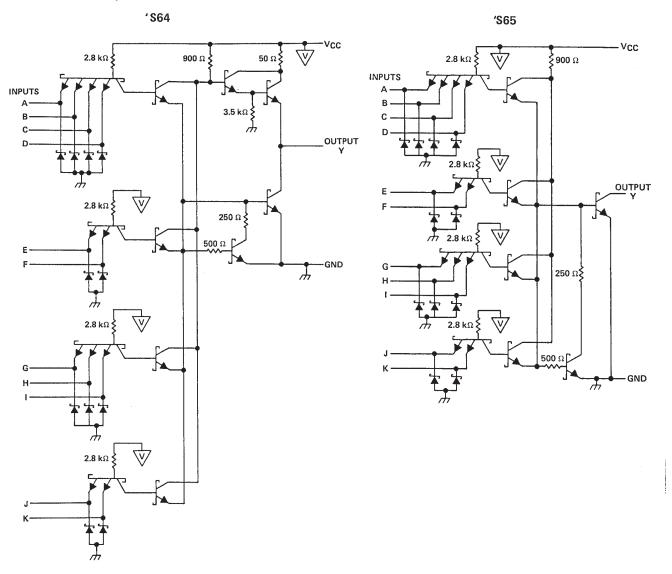
NC - No internal connection

## logic diagram (each device) (positive logic)



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# schematics (each gate)



Resistor values shown are nominal and in ohms.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		
Input voltage	• • • • • • • • • • • • • • • • • • • •	5.5 V
Off-state output voltage, 'S65		
Operating free-air temperature range:	SN54'	
	SN74'	0°C to 70°C
Storage temperature range		



## recommended operating conditions

		SN54S64			SN74S64			
	MIN	MIN NOM MAX MIN NOM I			MAX	AX UNIT		
V <sub>CC</sub> Supply voltage	4.5	5	5,5	4.75	5	5.25	V	
V <sub>IH</sub> High-level input voltage	2			2			V	
V <sub>IL</sub> Low-level input voltage			8,0			8.0	V	
IOH High-level output current			<del>- 1</del>			1	mA	
IOL Low-level output current			20			20	mA	
T <sub>A</sub> Operating free-air temperature	<b>– 55</b>		125	0		70	°C	

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT								
		TEGT CONDIT	TONS I.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	$I_1 = -18 \text{ mA}$				-1,2			- 1.2	V
V <sub>OH</sub>	V <sub>CC</sub> = MIN,	V <sub>1L</sub> = 0.8 V,	I <sub>OH</sub> = -1 mA	2.5	3.4		2.7	3.4		V
VOL	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	1 <sub>OL</sub> = 20 mA			0,5			0.5	V
կ	$V_{CC} = MAX$ ,	V <sub>1</sub> = 5.5 V				1			1	mA
ЧН	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				50			50	μΑ
HL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.5 V				- 2			- 2	mA
loss	V <sub>CC</sub> = MAX			- 40		-100	- 40		- 100	mA
Іссн	V <sub>CC</sub> = MAX,	V1 = 0			7	12.5		7	12,5	mA
ICCL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 4.5 V			8.5	16		8.5	16	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	IDITIONS	MIN TYP	MAX	UNIT
<sup>t</sup> PLH			B. = 200 O	0 - 15 - 5	3.5	5.5	ns
<sup>t</sup> PHL	Any		$R_L = 280 \Omega$ ,	C <sub>L</sub> = 15 pF	3.5	5.5	ns
t <sub>PLH</sub>	Ally	'	D 200 C	C. = 50 = 5	5		ns
t <sub>PHL</sub>			R <sub>L</sub> = 280 Ω,	C <sub>L</sub> = 50 pF	5.5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ} \text{C}$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

## recommended operating conditions

		SN54S65			SN74S65			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
V <sub>CC</sub> Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
V <sub>IH</sub> High-level input voltage	2			2			V	
V <sub>IL</sub> Low-level input voltage			8.0			8.0	V	
VOH High-level output voltage			5.5			5.5	V	
OL Low-level output current			20			20	mA	
T <sub>A</sub> Operating free-air temperature	<b>– 55</b>		125	0	·	70	°c	

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54S6	5	;			
	TEST CONDITIONS.	MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	UNIT
VIK	$V_{CC} = MIN$ , $I_{I} = -18 \text{ mA}$			1.2			1.2	V
ЮН	$V_{CC} = MIN$ , $V_{IL} = 0.8 \text{ V}$ , $V_{OH} = 5.5 \text{ V}$						0.25	
ЮП	$V_{CC} = MIN$ , $V_{IL} = 0.7 \text{ V}$ , $V_{OH} = 5.5 \text{ V}$		***************************************	0.25				mA
VOL	$V_{CC} = MIN$ , $V_{IH} = 2 V$ , $I_{OL} = 20 mA$		0.2	0.4		0.2	0.4	V
l <sub>l</sub>	$V_{CC} = MAX$ , $V_{\parallel} = 5.5 V$			1			1	mA
ItH .	$V_{CC} = MAX$ , $V_{I} = 2.7 V$			50			50	μΑ
اړړ	$V_{CC} = MAX$ , $V_1 = 0.5 V$			-2			- 2	mA
1ссн	$V_{CC} = MAX, V_I = 0$		6	11		6	11	mA
<sup>I</sup> CCL	$V_{CC} = MAX$ , $V_1 = 4.5 V$		8.5	16		8.5	16	mA

<sup>&</sup>lt;sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	MAX	UNIT	
t <sub>PLH</sub>			$R_1 = 280 \Omega$ ,	C: -15 -F	2	5	7.5	ns
<sup>t</sup> PHL	Any		n 200 12,	C <sub>L</sub> = 15 pF	2	5.5	8.5	ns
<sup>t</sup> PLH	Airy	'	D 200 O	0. = 50 = 5		8		ns
<sup>t</sup> PHL		R <sub>L</sub> = 280 Ω,	C <sub>L</sub> = 50 pF		6.5		ns	

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>^{\</sup>ddagger}$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C.





6-Feb-2020

### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	_	Pins	•	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
JM38510/07402BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07402BCA	Samples
JM38510/07402BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07402BDA	Samples
M38510/07402BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07402BCA	Samples
M38510/07402BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07402BDA	Samples
SN54S64J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54S64J	Samples
SNJ54S64J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54S64J	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.



# **PACKAGE OPTION ADDENDUM**

6-Feb-2020

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# W (R-GDFP-F14)

# CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



### NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
  Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



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